

UCC28250 1/8th Brick Reference Design

40-75V input, 12V/15A Output

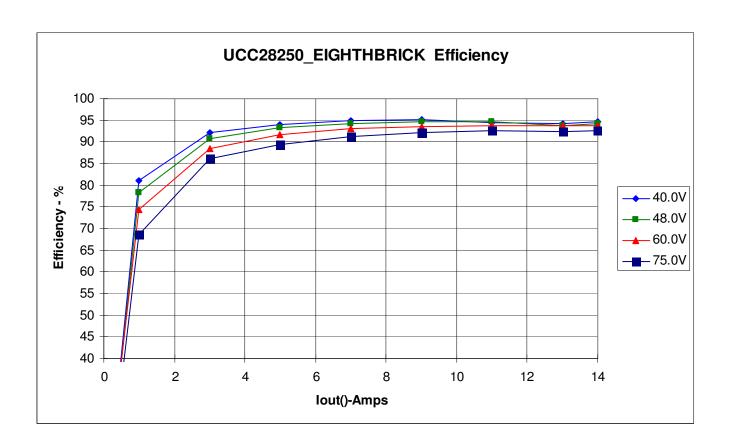
Test Report



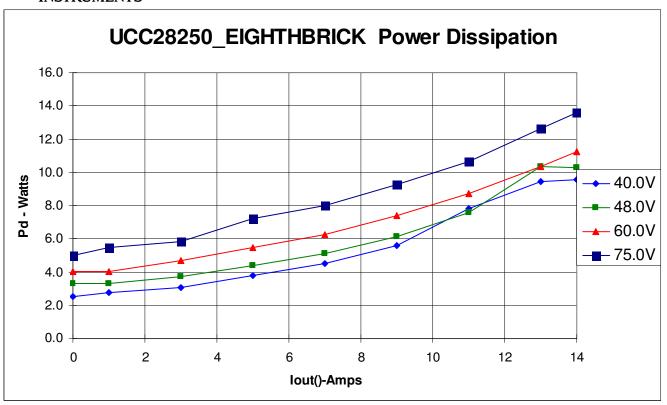
This document refers to test results for a standard Eighth Brick reference design featuring Texas Instruments parts.

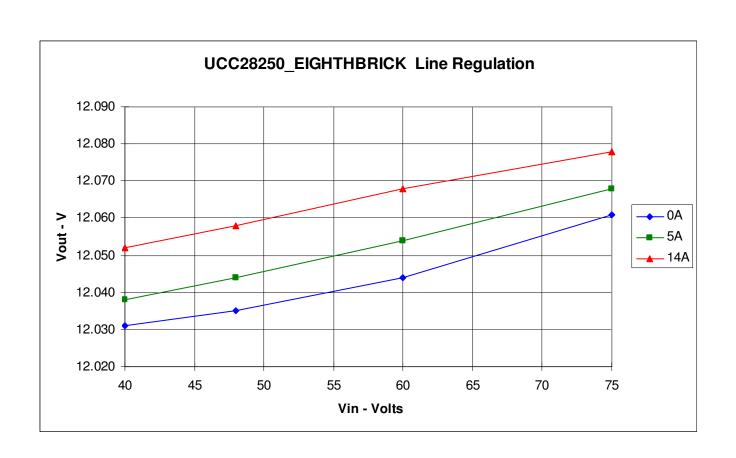
Design criteria: Vout=12v @ 15 Amps, Vin range=40-75 Volts DC. Secondary side control.

TI content: UCC28250 PWM controller, UCC27201 High and Low side Mosfet Driver, UCC27324 Low side Mosfet Driver, UCC25230 Bias PWM Contoller, ISO7220 Digital Isolator, OPA365 High Performance Op Amp, TPS76201 Linear regulator, LM4041 Shunt Regulator





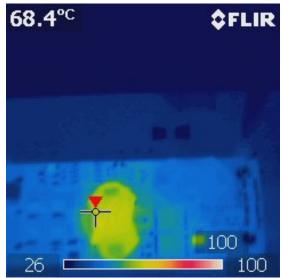






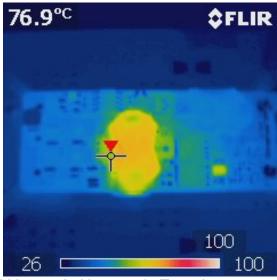


Thermal images of top side.

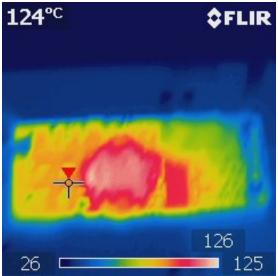


Vin=40V lout=0A, Hot spot is Transformer core. 0 cfm





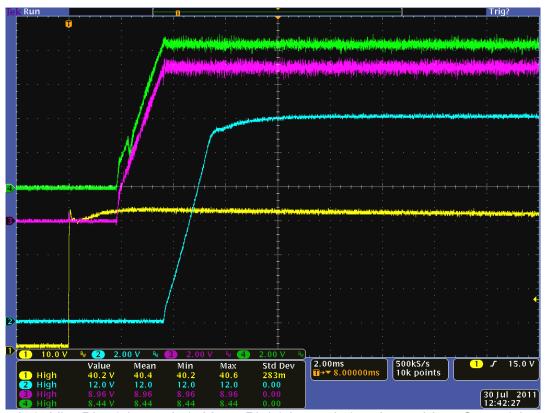
Vin=60V lout=0A, Hot spot is Transformer core. 0 cfm



Vin=40V lout=15A, Hot spot is PCB near primary mosfets. 0 cfm

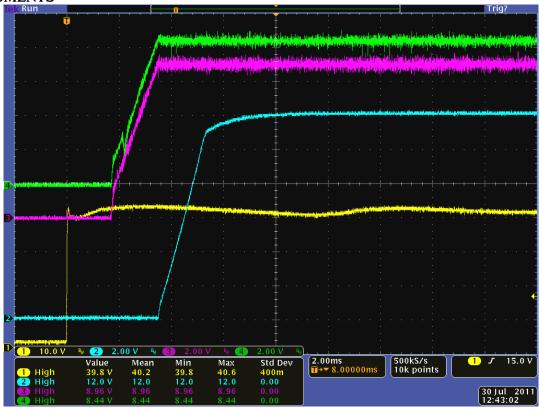


Start Up

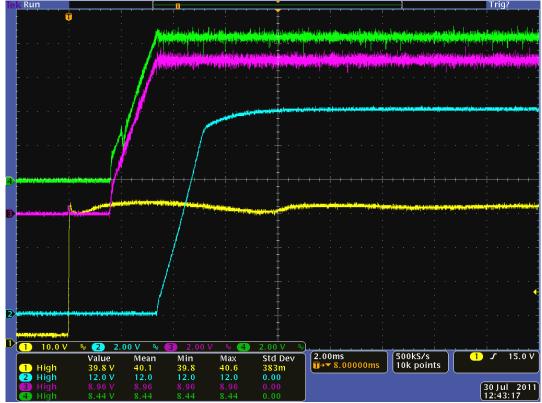


Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=40V lout= 0A External capacitance=150uf



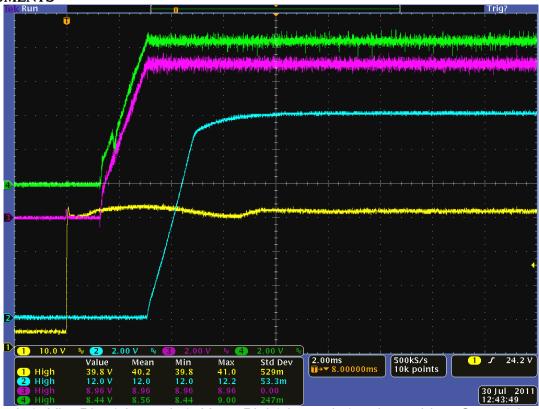


Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=40V lout= 5A External capacitance=150uf

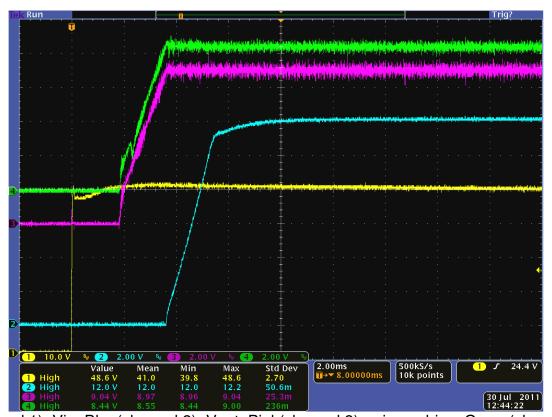


Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=40V lout= 10A External capacitance=150uf



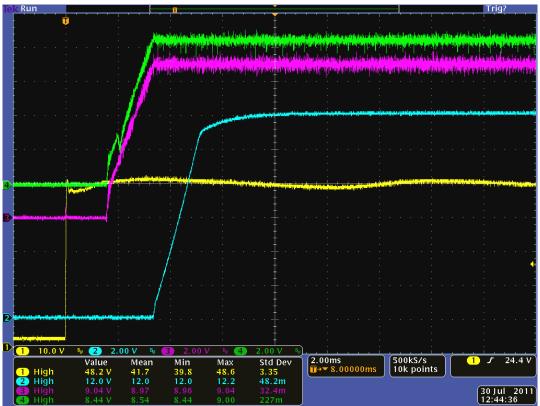


Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=40V lout= 15A External capacitance=150uf



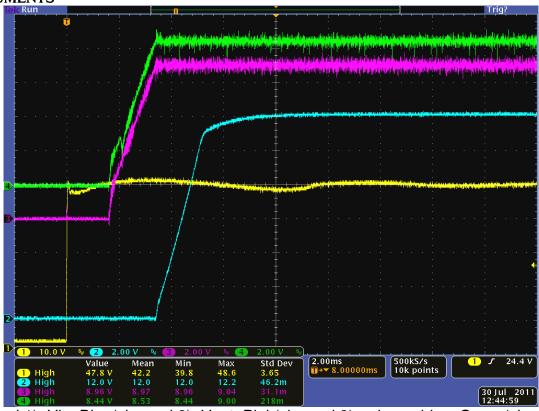
Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel

4)=secondary bias; Vin=48V lout= 0A External capacitance=150uf

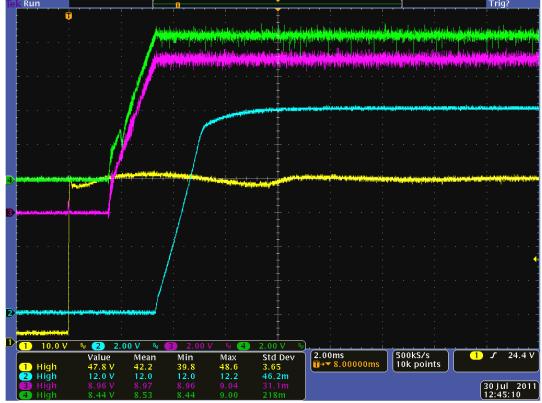


Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=48V lout= 5A External capacitance=150uf



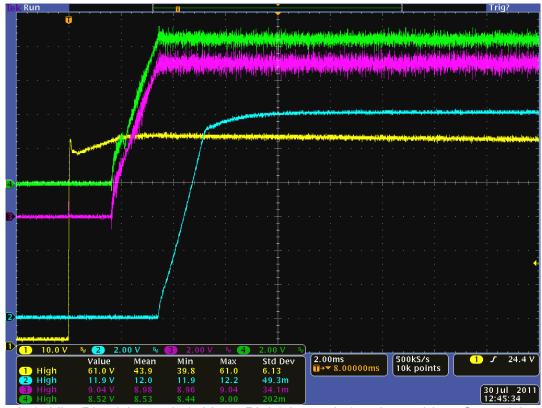


Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=48V lout= 10A External capacitance=150uf

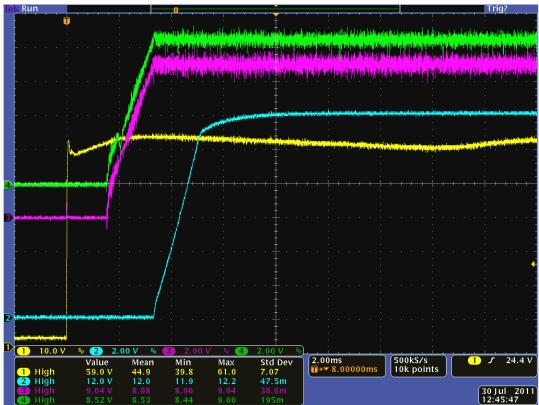


Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=48V lout= 15A External capacitance=150uf

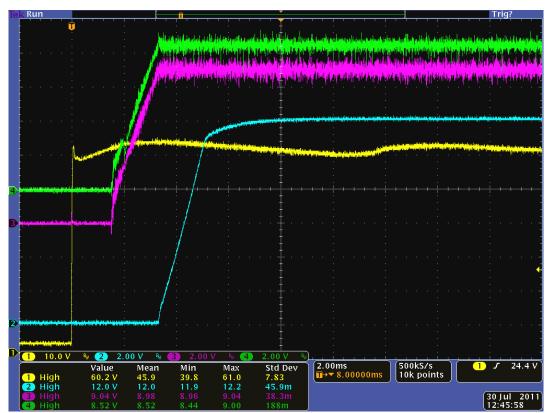




Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=60V lout= 0A External capacitance=150uf

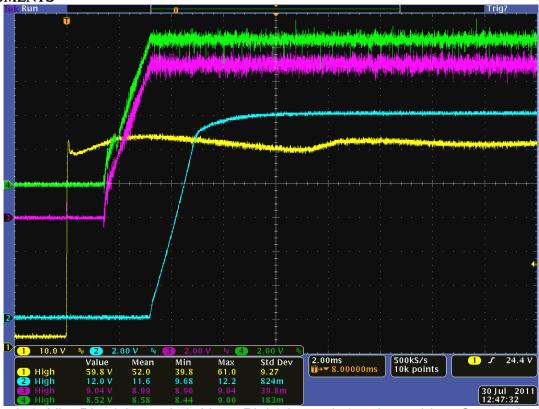


Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel



Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=60V lout= 10A External capacitance=150uf

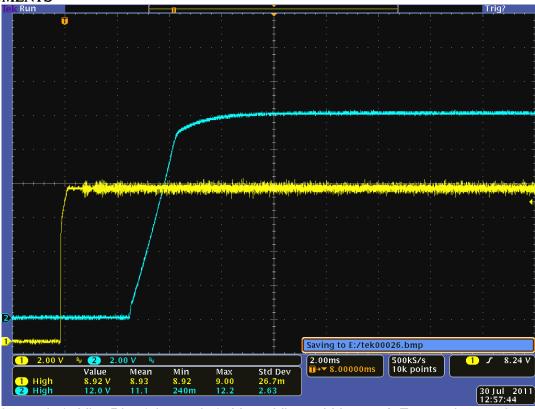




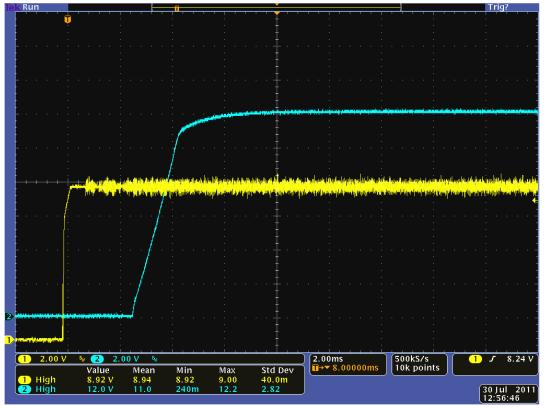
Yellow(channel 1)=Vin, Blue(channel 2)=Vout, Pink(channel 3)=primary bias, Green(channel 4)=secondary bias; Vin=60V lout= 15A External capacitance=150uf

Enable vs Vout



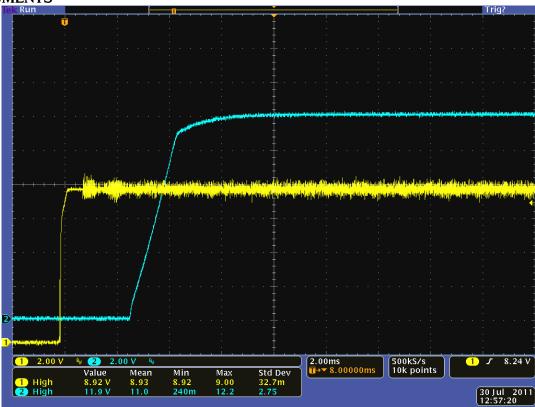


Yellow(channel 1)=Vin, Blue(channel 2)=Vout; Vin=40V lout=5A External capacitance=150uf



Yellow(channel 1)=Vin, Blue(channel 2)=Vout; Vin=48V lout=5A External capacitance=150uf





Yellow(channel 1)=Vin, Blue(channel 2)=Vout; Vin=60V lout=5A External capacitance=150uf

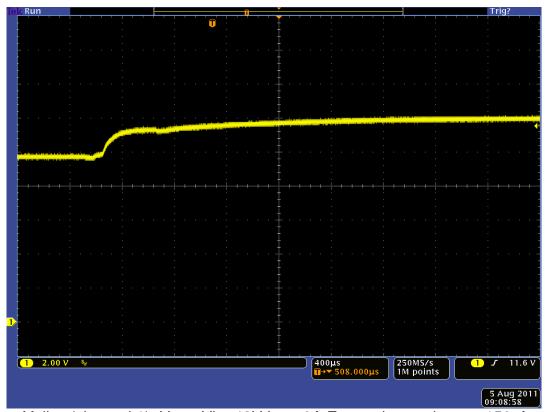
Vout with 6v Prebias



Yellow(channel 1)=Vout; Vin=48V lout=0A External capacitance=150uf



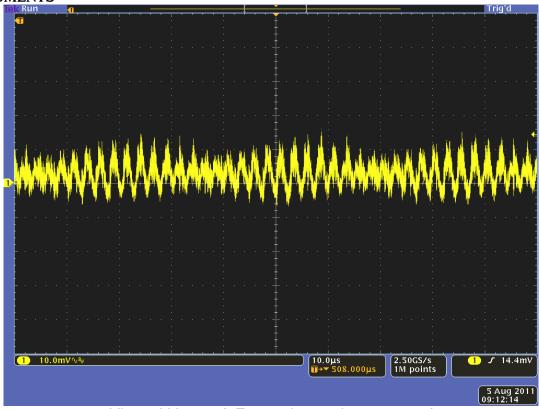
Vout with 10v Prebias



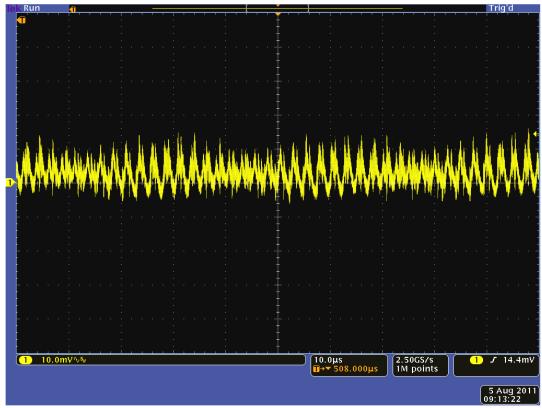
Yellow(channel 1)=Vout; Vin=48V lout=0A External capacitance=150uf

Output Ripple





Vin=48V lout=0A External capacitance=150uf

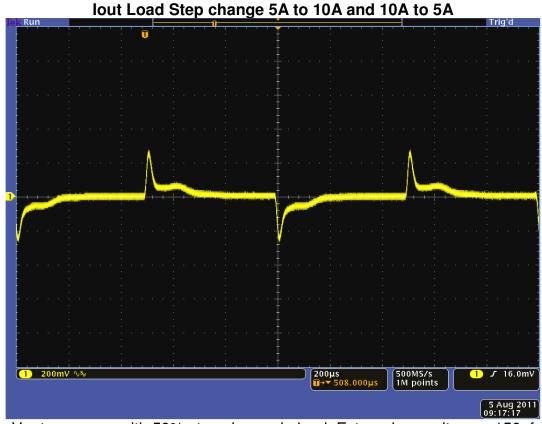


Vin=48V lout=15A External capacitance=150uf



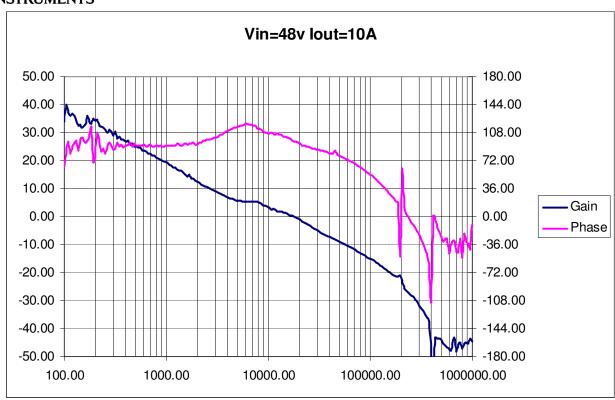


Yellow(channel 1)=Vin, Blue(channel 2)=Vout; lout=5A 400mv deviation External capacitance=150uf

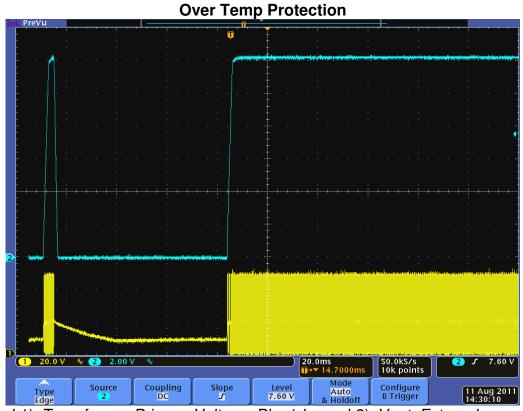


Vout response with 50% step change in load. External capacitance=150uf





External capacitance=150uf



Yellow(channel 1)=Transformer Primary Voltage, Blue(channel 2)=Vout; External capacitance=150uf



The board was externally heated in the area of the sense thermistor for the Over temp detection circuit. The waveforms show the hiccup delay before switching resumes and the output returning with no overshoot after the temperature is reduced.



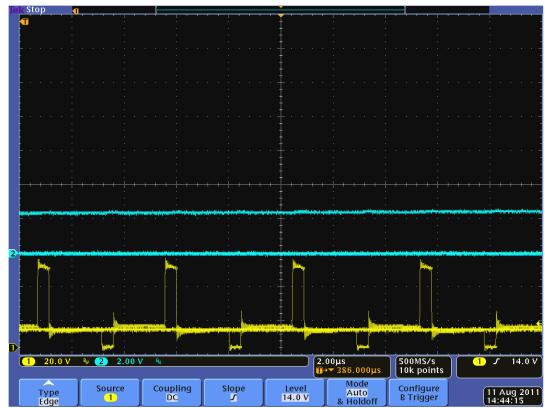
Yellow(channel 1)=Transformer Primary Voltage External capacitance=150uf Expanded view of the primary voltage of the power transformer showing no asymmetry during the hiccup recovery period.

Over Current



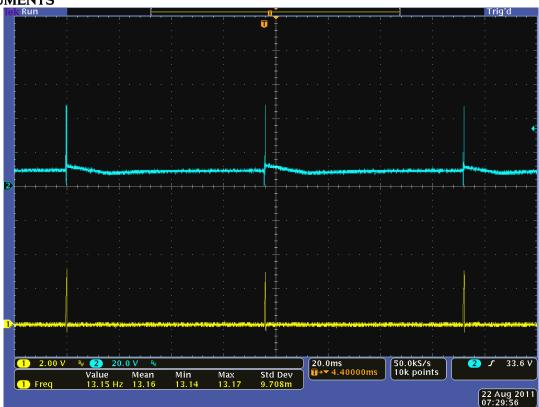


Yellow(channel 1)=Transformer Primary Voltage, Blue(channel 2)=Vout; Iout=20A External capacitance=150uf



Yellow(channel 1)=Transformer Primary Voltage, Blue(channel 2)=Vout; lout=20A External capacitance=150uf Expanded view of the primary voltage of the power transformer showing no asymmetry during the hiccup recovery period.





Yellow(channel 1)= Vout, Blue(channel 2)= Transformer Primary Voltage; lout=20A External capacitance=150uf. Converter in Hiccup mode during Over current condition. Featuring very low power dissipation when exhibiting an over current fault.



Summary

The intent of this design was to highlight some of features of the UCC28250 PWM controller, such as a programmable hiccup timer for fault conditions, prebias startup capability, adjustable timing on gate drive signals for synchronous rectifiers and the ability to have feed forward compensation with a secondary side controller.

The secondary side bias power and startup is provided by Texas Instruments UCC25230 bias supply controller with built in power devices. This device is capable of 75v operation with 100v surges and up to 250mA of peak current. By utilizing a forward flyback topology allows for simpler magnetic design for the bias supply to provide controller power for both primary and secondary side circuitry. As can be observed by the previous data, a high efficiency eighth brick reference design can be achieved using Texas Instruments comprehensive line of power solutions.

Notes:

All data was taken at room ambient approximately 25 degrees C, minimal airflow of 200LFM unless otherwise noted. No data was taken at extreme cold or elevated temperatures. The design would need to be optimized for specific applications and specifications.

Over current sensing is done by amplifying a differential voltage across an embedded copper trace on the secondary side.

This reference design does not have any compensation for temperature or input voltage changes for the current sensing method used. It would need to be modified for an end user application to allow for input voltage range, printed circuit board materials and temperature variations.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2021, Texas Instruments Incorporated